

## Product Summary

| $V_{(BR)DSS}$ | $R_{DS(on)TYP}$ | $I_D$ |
|---------------|-----------------|-------|
| 650V          | 40mΩ@10V        | 50A   |



**合肥矽普半导体**

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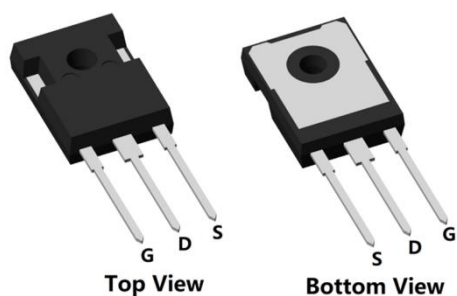
## Feature

- Fast Switching
- Low Gate Charge and  $R_{DS(on)}$
- 100% Single Pulse avalanche energy Test

## Applications

- PWM Application
- Hard switched and high frequency circuits
- Power Management

## Package

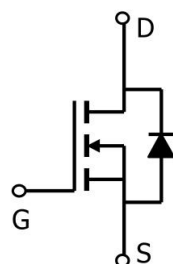


Top View

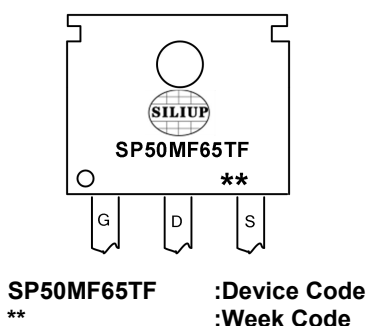
Bottom View

TO-247(1:G 2:D 3:S)

## Circuit diagram



## Marking



## Order Information

| Device     | Package | Unit/Tube |
|------------|---------|-----------|
| SP50MF65TF | TO-247  | 30        |

**Absolute maximum ratings (Ta=25°C, unless otherwise noted)**

| Parameter                                  | Symbol          | Rating     | Units |
|--------------------------------------------|-----------------|------------|-------|
| Drain-Source Voltage                       | $V_{DS}$        | 650        | V     |
| Gate-Source Voltage                        | $V_{GS}$        | $\pm 30$   | V     |
| Continuous Drain Current (Tc=25°C)         | $I_D$           | 50         | A     |
| Continuous Drain Current (Tc=100°C)        | $I_D$           | 32A        | A     |
| Pulsed Drain Current                       | $I_{DM}$        | 200        | A     |
| Single Pulse Avalanche Energy <sup>1</sup> | $E_{AS}$        | 172        | mJ    |
| Power Dissipation (Tc=25°C)                | $P_D$           | 198        | W     |
| Thermal Resistance Junction-to-Case        | $R_{\theta JC}$ | 0.63       | °C/W  |
| Storage Temperature Range                  | $T_{STG}$       | -55 to 150 | °C    |
| Operating Junction Temperature Range       | $T_J$           | -55 to 150 | °C    |

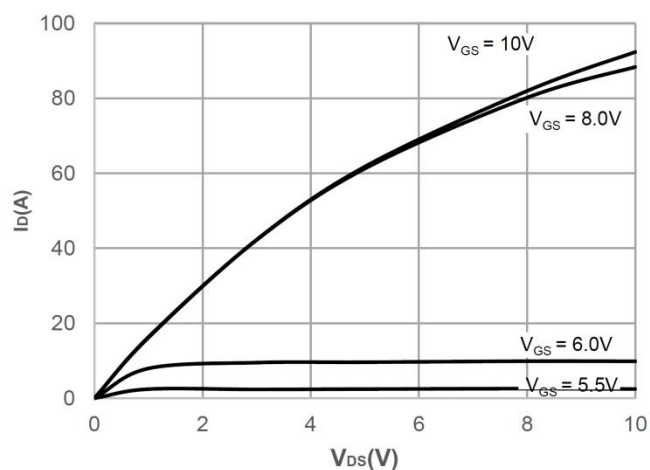
**Electrical characteristics (Ta=25°C, unless otherwise noted)**

| Parameter                             | Symbol              | Conditions                                                 | Min. | Typ. | Max. | Unit |
|---------------------------------------|---------------------|------------------------------------------------------------|------|------|------|------|
| Static Characteristics                |                     |                                                            |      |      |      |      |
| Drain-Source Breakdown Voltage        | BV <sub>DSS</sub>   | I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V               | 650  | -    | -    | V    |
| Drain-Source Leakage Current          | I <sub>DSS</sub>    | V <sub>DS</sub> = 520V, V <sub>GS</sub> = 0V               | -    | -    | 1    | uA   |
| Gate-Source Leakage Current           | I <sub>GSS</sub>    | V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V               | -    | -    | ±100 | nA   |
| Gate Threshold Voltage                | V <sub>GS(th)</sub> | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA | 3    | 4    | 5    | V    |
| Static Drain-Source On-Resistance     | R <sub>DS(ON)</sub> | V <sub>GS</sub> = 10V, I <sub>D</sub> = 35A                | -    | 40   | 50   | mΩ   |
| Dynamic characteristics               |                     |                                                            |      |      |      |      |
| Input Capacitance                     | C <sub>iSS</sub>    | VDS=400V , VGS=0V , f=1MHz                                 | -    | 4240 | -    | pF   |
| Output Capacitance                    | C <sub>oss</sub>    |                                                            | -    | 64   | -    |      |
| Reverse Transfer Capacitance          | C <sub>rSS</sub>    |                                                            | -    | 45   | -    |      |
| Total Gate Charge                     | Q <sub>g</sub>      | VDS=400V , VGS=10V , ID=20A                                | -    | 81   | -    | nC   |
| Gate-Source Charge                    | Q <sub>gs</sub>     |                                                            | -    | 26   | -    |      |
| Gate-Drain Charge                     | Q <sub>gd</sub>     |                                                            | -    | 24   | -    |      |
| Switching Characteristics             |                     |                                                            |      |      |      |      |
| Turn-On Delay Time                    | T <sub>d(on)</sub>  | VDD=400V, VGS=10V , RG=2Ω, ID=20A                          | -    | 34   | -    | nS   |
| Rise Time                             | T <sub>r</sub>      |                                                            | -    | 11   | -    |      |
| Turn-Off Delay Time                   | T <sub>d(off)</sub> |                                                            | -    | 124  | -    |      |
| Fall Time                             | T <sub>f</sub>      |                                                            | -    | 5    | -    |      |
| Diode Characteristics                 |                     |                                                            |      |      |      |      |
| Diode Forward Voltage                 | V <sub>SD</sub>     | VGS=0V , IS=1A , TJ=25℃                                    | -    | -    | 1.2  | V    |
| Maximum Body-Diode Continuous Current | I <sub>S</sub>      |                                                            | -    | -    | 40   | A    |
| Reverse recover time                  | T <sub>rr</sub>     | Is=20A, di/dt=100A/us, Tj=25℃                              | -    | 161  | -    | nS   |
| Reverse recovery charge               | Q <sub>rr</sub>     |                                                            | -    | 1.1  | -    | uC   |

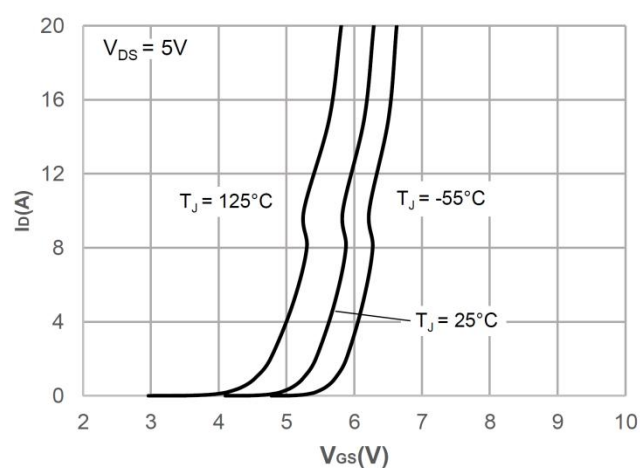
**Note :**

1. The test condition is  $V_{DD}=100V, V_{GS}=10V, L=60mH, R_G=25\Omega$

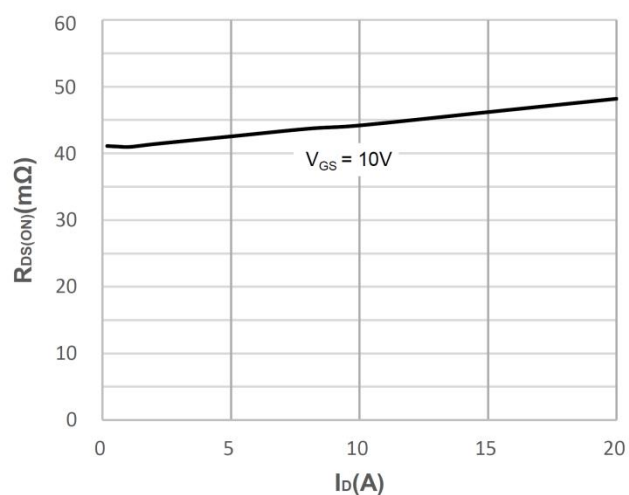
## Typical Characteristics



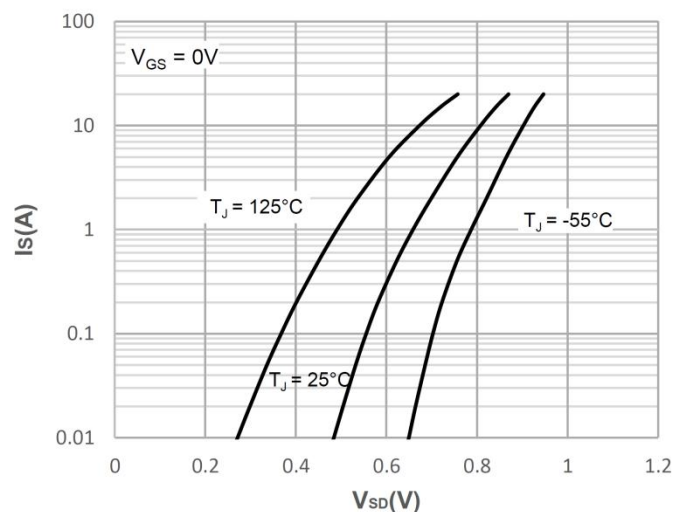
Output Characteristics



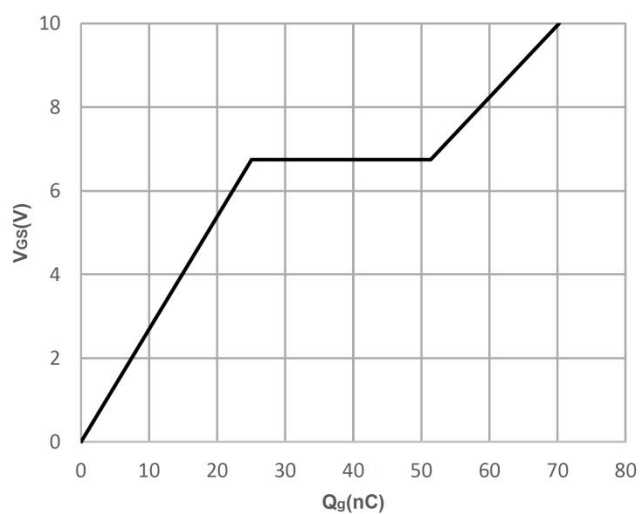
Typical Transfer Characteristics



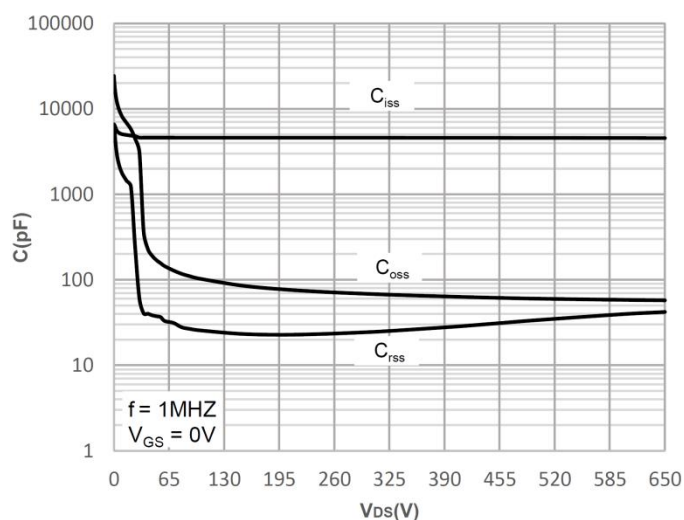
On-resistance vs. Drain Current



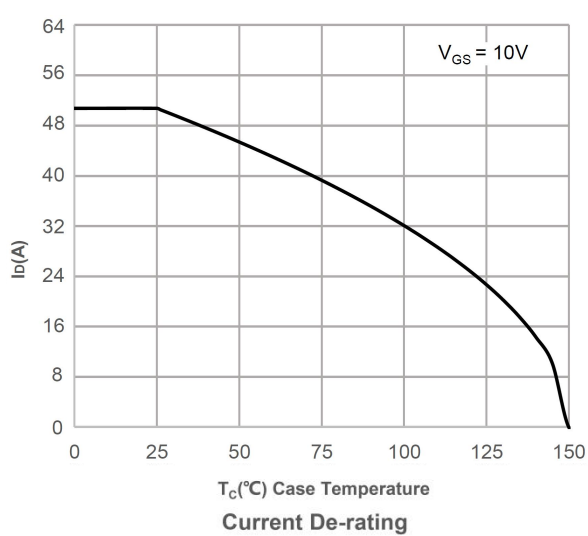
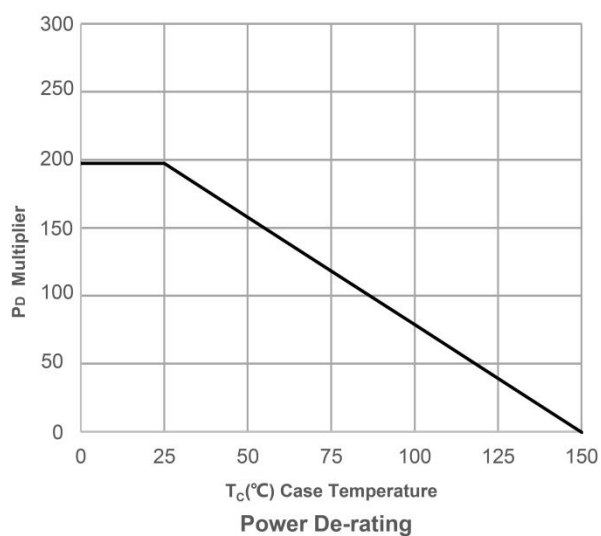
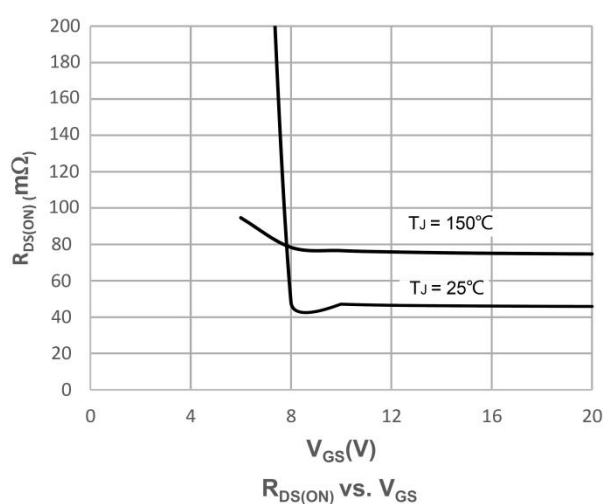
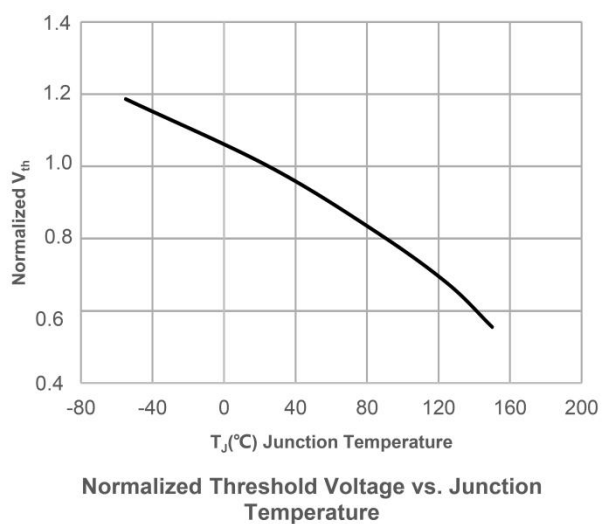
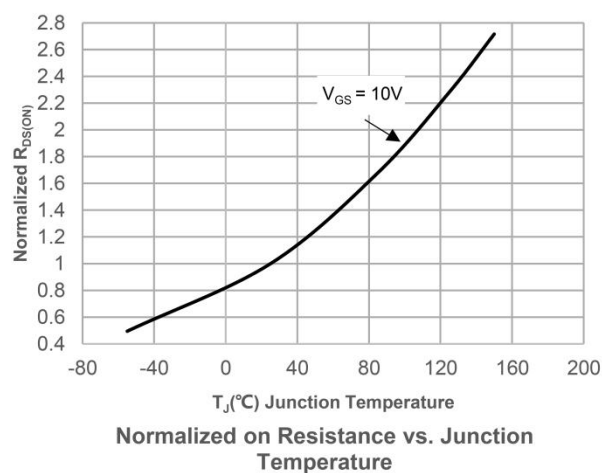
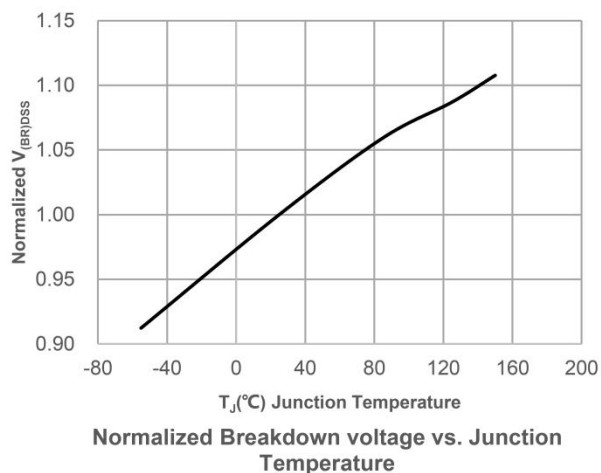
Body Diode Characteristics

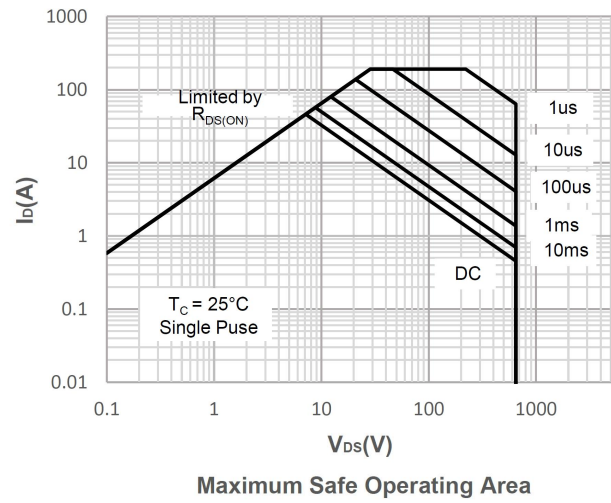
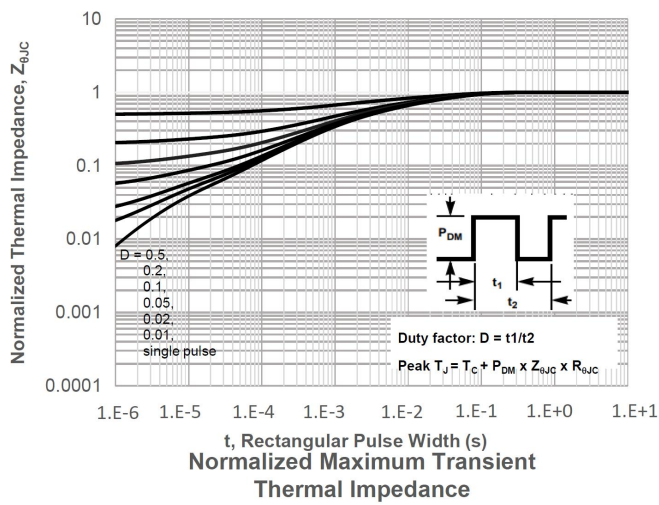


Gate Charge Characteristics

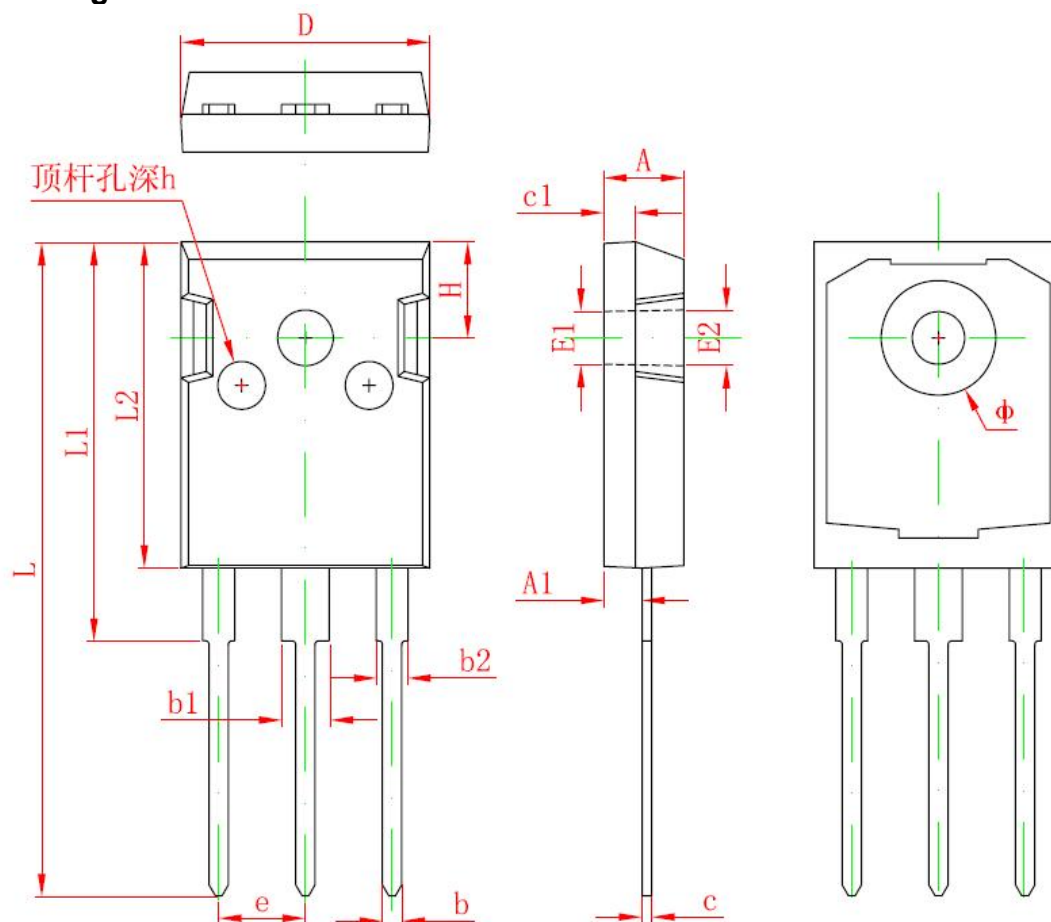


Capacitance Characteristics





# TO-247 Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 4.850                     | 5.150  | 0.191                | 0.200 |
| A1     | 2.200                     | 2.600  | 0.087                | 0.102 |
| b2     | 1.800                     | 2.200  | 0.071                | 0.087 |
| b      | 1.000                     | 1.400  | 0.039                | 0.055 |
| b1     | 2.800                     | 3.200  | 0.110                | 0.126 |
| c      | 0.500                     | 0.700  | 0.020                | 0.028 |
| c1     | 1.900                     | 2.100  | 0.075                | 0.083 |
| D      | 15.450                    | 15.750 | 0.608                | 0.620 |
| E1     | 3.500 REF.                |        | 0.138 REF.           |       |
| E2     | 3.600 REF.                |        | 0.142 REF.           |       |
| L      | 40.900                    | 41.300 | 1.610                | 1.626 |
| L1     | 24.800                    | 25.100 | 0.976                | 0.988 |
| L2     | 20.300                    | 20.600 | 0.799                | 0.811 |
| Φ      | 7.100                     | 7.300  | 0.280                | 0.287 |
| e      | 5.450 TYP.                |        | 0.215 TYP.           |       |
| H1     | 5.980 REF.                |        | 0.235 REF.           |       |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |